

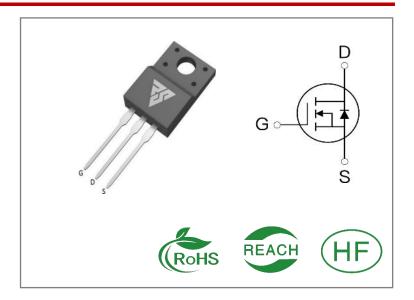
ID	R <sub>DS</sub> (ON)(Typ)	VDSS
13A	0.39Ω	500V

## **Applications:**

- Switch Mode Power Supply(SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)

#### **Features:**

- Fast switching speed
- 100% avalanche tested
- Improved dv/dt capability



## **Ordering Information**

Part Number	Package	Marking	Packing	Qty.
RS13N50F	T0-220F	RS13N50F	Tube	50 PCS

## Absolute Maximun Ratings Tc= 25℃ unless otherwise specified

Symbol	Parameter	RS13N50F	Units
VDSS	Drain-to-Source Voltage	500	V
ID	Continuous Drain Current TC=25℃	13	Δ
IDM	Pulsed Drain Current (Note*1)	52	Α
PD	Power Dissipation	49	W
VGS	Gate- to- Source Voltage	±30	V
EAS	Single Pulse Avalanche Engergy L = 10mH, VDD = 50V, RG = 25 Ω	352	mJ
	Maximum Temperature for Soldering		
TL TPKG	Leads at 0.063in(1.6mm)from Case for 10 seconds Package Body for 10 seconds	300 260	${\mathbb C}$
TJ and TSTG	Operating Junction and Storage Temperature Range	-55 to 150	

<sup>\*</sup> Drain Current Limited by Maximum Junction Temperature

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" Table may cause permanent damage to the device.



### **Thermal Resistance**

Symbol	Parameter	RS13N50F	Units	Test Conditions
RθJC	Junction-to-Case	2.55	°C/W	Drain lead soldered to water cooled heatsink, PD adjusted for a peak junction temperature of + 1 5 0 $^{\circ}$ C
RθJA	Junction-to- Ambient	62.5		1 cubic foot chamber,free air.

## **OFF Characteristics** TJ= 25℃ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BVDSS	Drain- to- source Breakdown Voltage	500			V	VGS=0V,ID=250μ A
IDSS	Drain- to- Source Leakage Current			1	μΑ	VDS=500V,VGS= 0V
IGSS	Gate- to- Source Forward Leakage			100	<b></b> Λ	VGS=30V ,VDS=0 V
1033	Gate- to- Source Reverse Leakage			-100	nA	VGS=-30V ,VDS= 0V

# ON Characteristics TJ=25°C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
RDS(on)	Static Drain- to- Source On- Resistance(Note*2)		0.39	0.46	Ω	VGS=10V,ID=6.5 A
VGS(TH	Gate Threshold Voltage	3		4	٧	VGS=VDS,ID=25 0μA

## Resistive Switching Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
td(ON)	Turn- on Delay Time		43.2			
trise	Rise Time		24.8			VDS=250V
td(OFF)	Turn- OFF Delay Time		131. 8		nS	ID=13A RG=25Ω
tfall	Fall Time		42.6			



**Dynamic Characteristics** Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Ciss	Input Capacitance		1569			VGS=0V
Coss	Output Capacitance		171		pF	VDS=25V
Crss	Reverse Transfer Capacitance		5			f=1.0MHz
Qg	Total Gate Charge		30.9			VDS=400V
Qgs	Gate- to- Source Charge		7.8		nC	ID=13A
Qgd	Gate-to-Drain(" Miller") Charge		10.6			VGS=10V

### **Source-Drain Diode Characteristics**

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
IS	Continuous Source Current			13	Α	Integral pn- diode
ISM	Maximum Pulsed Current			52	Α	in MOSFET
VSD	Diode Forward Voltage			1.4	V	IS=6.5A,VGS=0V
trr	Reverse Recovery Time		307		nS	VGS=0V
Qrr	Reverse Recovery Charge		3.5		μC	IS=13A,di/dt=100 A/μs

### Notes:

<sup>\* 1.</sup> Repetitive rating, pulse width limited by maximum junction temperature.

<sup>\* 2.</sup> Pulse Test: Pulse width ≤ 300μs, Duty Cycle ≤ 1%



### **Typical Feature Curve**

Figure 1. Output Characteristics (T<sub>1</sub> = 25°C)

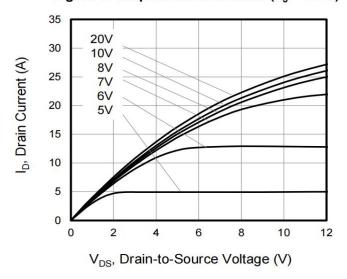


Figure 3. Drain Current vs. Temperature

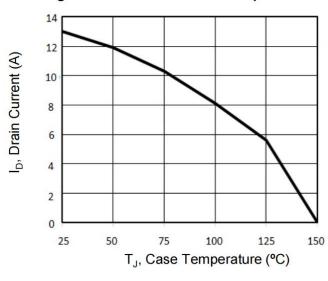


Figure 5. Transfer Characteristics 16 14  $T_J = 25^{\circ}C$ I<sub>D</sub>, Drain Current (A) 12 10 8 T<sub>J</sub> = 150°C 6 4 2 0 0 10 V<sub>GS</sub>, Gate-to-Source Voltage (V)

Figure 2. Body Diode Forward Voltage

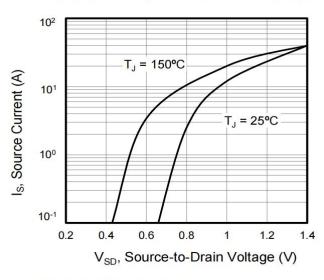


Figure 4. BV<sub>DSS</sub> Variation vs. Temperature

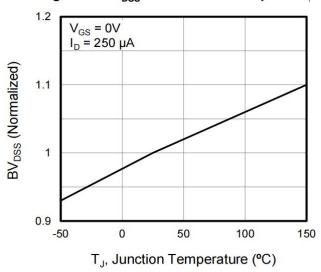


Figure 6. On-Resistance vs. Temperature

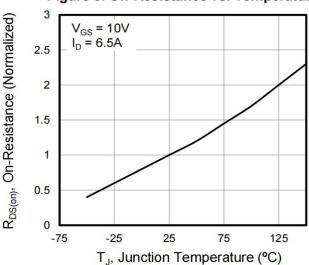
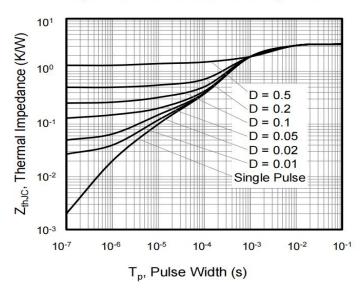


Figure 7. Capacitance  $\begin{array}{c} 10000 \\ \hline (1000) \\ \hline (100) \\ \hline (100)$ 

Figure 8. Gate Charge

Solve  $V_{DD} = 100V$   $V_{DD} = 250V$   $V_{DD} = 400V$   $V_{DD} = 400V$ 

Figure 9. Transient Thermal Impedance



## **Test Circuits and Waveforms**

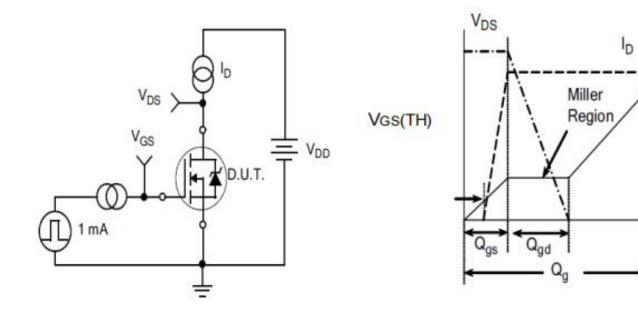


Figure10.
Gate Charge Test Circuit

Figure11.
Gate Charge Waveform

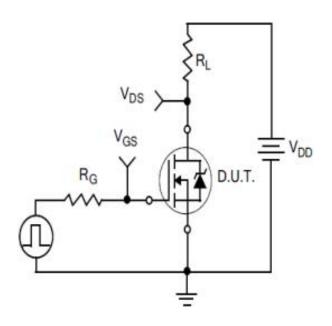


Figure12.
Resistive Switching Test Circuit

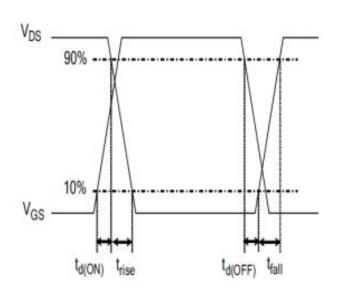


Figure 13.
Resistive Switching Waveforms

### **Test Circuits and Waveforms**

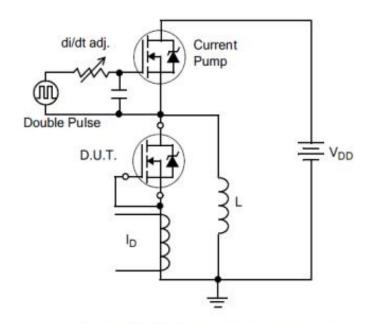


Figure 14. Diode Reverse Recovery
Test Circuit

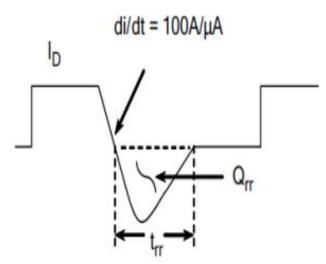


Figure 15. Diode Reverse Recovery
Waveform

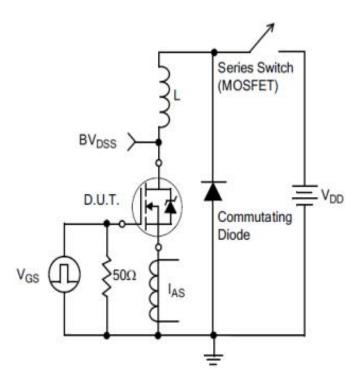
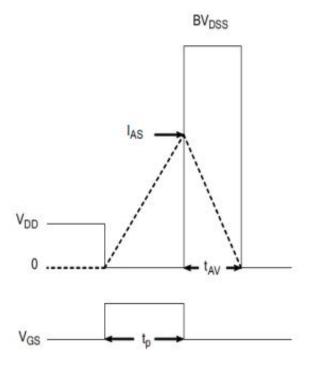
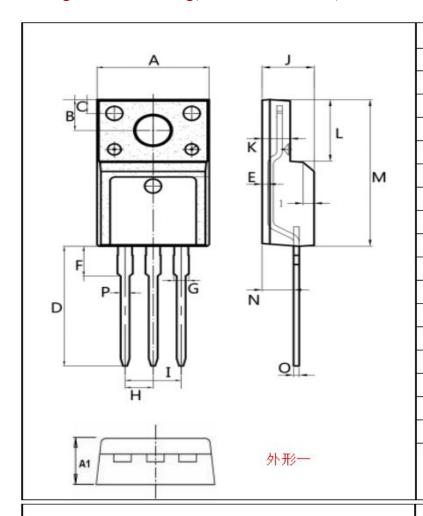


Figure 16. Unclamped Inductive Switching Test Circuit



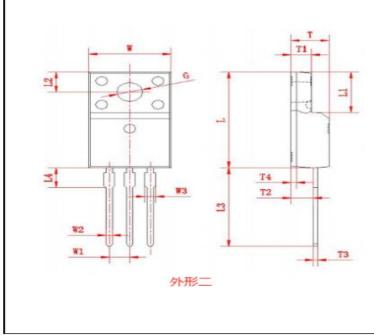


# Package outline drawing(TO-220F Unit: mm)



Dim.	Min.	Max.
Α	9.95	10.36
A1	4.5	5.0
В	2.95	3.25
С	1.25	1.45
D	12.60	13.60
E	0.40	0.60
F	2.8	3.5
G	1.30	1.45
Н	(2.54	(1)
1	(5.08	3)
J	4.60	4.75
K	2.45	2.65
L	6.5	6.8
М	15.4	16.0
N	2.25	3.05
0	0.45	0.55
Р	0.70	0.90

All Dimensions in millimeter



Dim.	Min.	Max.		
W	9.95	10.36		
W1	(2.54)			
W2	0.70	0.90		
W3	1.25	1.47		
L	15.67	16.07		
L1	6.48	6.88		
L2	3.2	3.4		
L3	12.6	13.6		
L4	(3.23	3)		
Т	4.50	4.90		
T1	2.34	2.74		
T2	2.25	2.95		
Т3	0.45	0.60		
T4	(0.	70)		
G	3.08	3.28		



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DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B
IPB80P04P405ATMA2 2N7002W-G MCAC30N06Y-TP MCQ7328-TP BXP7N65D BXP4N65F AOL1454G WMJ80N60C4 BXP2N20L
BXP2N65D BXT1150N10J BXT1700P06M TSM60NB380CP ROG RQ7L055BGTCR DMNH15H110SK3-13 SLF10N65ABV2
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